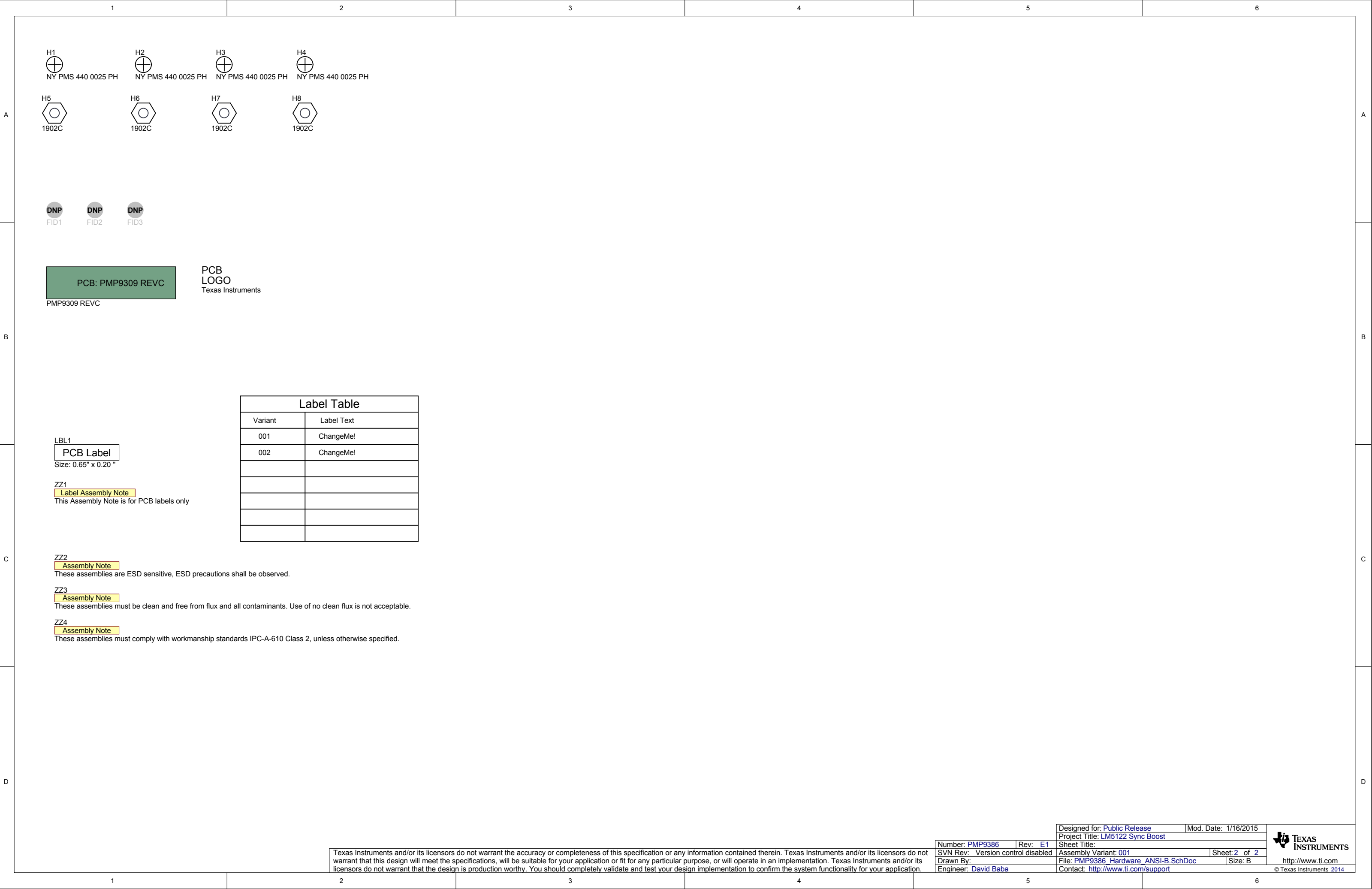


Vin = 14VDC to 15.5VDC

NOTE:
Cx1 is a bulk electrolytic capacitor
placed to dampen the input supply
voltage

NOTE:
Cx2 is kluged onto the board very close to Q1
Cx3 is placed in the positions occupied by C8 and C9

*NOTE1: All components
marked with "DNP" (which
denotes "Do Not Populate") are
components that should NOT be
installed in the circuit.



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